









SN74AVC16T245-Q1

SCES778B - SEPTEMBER 2008 - REVISED MARCH 2024

# SN74AVC16T245-Q1 16-Bit Dual-Supply Bus Transceiver With Configurable Voltage Translation and 3-State Outputs

#### 1 Features

- Qualified for Automotive Applications
- AEC-Q100 Qualified With the Following Results:
  - Device Temperature Grade 1: -40°C to 125°C **Ambient Operating Temperature Range**
  - Device HBM ESD Classification Level H3B (JESD 22 A114-A)
  - Device CDM ESD Classification Level C5 (JESD 22 C101)
- Control Inputs V<sub>IH</sub>/V<sub>IL</sub> Levels Are Referenced to V<sub>CCA</sub> Voltage
- V<sub>CC</sub> Isolation Feature If Either V<sub>CC</sub> Input is at GND, Both Ports Are in the High-Impedance State
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2V to 3.6V Power-Supply Range
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- I/Os Are 4.6V Tolerant
- Maximum Data Rates
  - 380Mbps (1.8V to 3.3V Translation)
  - 200Mbps (<1.8V to 3.3V Translation)
  - 200Mbps (Translate to 2.5V or 1.8V)
  - 150Mbps (Translate to 1.5V)
  - 100Mbps (Translate to 1.2V)
- Latch-Up Performance Exceeds 100mA Per JESD 78, Class II

# 2 Applications

- **Telematics**
- Clusters
- **Head Units**
- **Navigation Systems**

# 3 Description

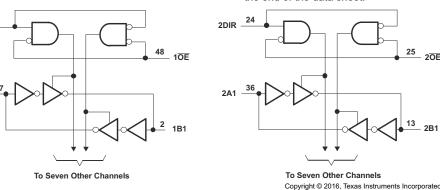
The SN74AVC16T245-Q1 is a 16-bit noninverting bus transceiver that uses two separate configurable power-supply rails. The SN74AVC16T245-Q1 is optimized to operate with  $V_{CCA}$  or  $V_{CCB}$  set at 1.4V to 3.6V. It is operational with  $V_{CCA}$  or  $V_{CCB}$  as low as 1.2V. The A port is designed to track V<sub>CCA</sub>. V<sub>CCA</sub> accepts any supply voltage from 1.2V to 3.6V. The B port is designed to track V<sub>CCB</sub>. V<sub>CCB</sub> accepts any supply voltage from 1.2V to 3.6V. This allows for universal low-voltage bidirectional translation between any of the 1.2V, 1.5V, 1.8V, 2.5V, and 3.3V voltage nodes.

The SN74AVC16T245-Q1 designed asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable ( OE) input can be used to disable the outputs so the buses effectively are isolated.

## **Device Information**

PART NUMBER	PACKAGE <sup>(1)</sup>	BODY SIZE (NOM)
SN74AVC16T245-Q1	TVSOP (48)	9.70mm × 4.40mm

For all available packages, see the orderable addendum at the end of the data sheet.



Logic Diagram (Positive Logic)



# **Table of Contents**

1 Features	8.2 Functional Block D
2 Applications1	8.3 Feature Description
3 Description1	8.4 Device Functional
4 Description (continued)3	9 Application and Impl
5 Pin Configuration and Functions4	9.1 Application Inform
6 Specifications6	9.2 Typical Application
6.1 Absolute Maximum Ratings6	10 Power Supply Reco
6.2 ESD Ratings6	11 Layout
6.3 Recommended Operating Conditions7	11.1 Layout Guideline
6.4 Thermal Information7	11.2 Layout Example.
6.5 Electrical Characteristics8	12 Device and Docume
6.6 Switching Characteristics: V <sub>CCA</sub> = 1.2 V9	12.1 Documentation S
6.7 Switching Characteristics: V <sub>CCA</sub> = 1.5 V ± 0.1 V9	12.2 Receiving Notific
6.8 Switching Characteristics: V <sub>CCA</sub> = 1.8 V ± 0.15 V10	12.3 Support Resourc
6.9 Switching Characteristics: V <sub>CCA</sub> = 2.5 V ± 0.2 V10	12.4 Trademarks
6.10 Switching Characteristics: V <sub>CCA</sub> = 3.3 V ± 0.3 V 11	12.5 Electrostatic Disc
6.11 Operating Characteristics11	12.6 Glossary
6.12 Typical Characteristics12	13 Revision History
7 Parameter Measurement Information14	14 Mechanical, Packag
8 Detailed Description15	Information
8.1 Overview	

8.∠ Functional Block Diagram	. 15
8.3 Feature Description	.15
8.4 Device Functional Modes	
9 Application and Implementation	16
9.1 Application Information	
9.2 Typical Application	
10 Power Supply Recommendations	
11 Layout	18
11.1 Layout Guidelines	
11.2 Layout Example	19
12 Device and Documentation Support	.20
12.1 Documentation Support	20
12.2 Receiving Notification of Documentation Updates.	20
12.3 Support Resources	20
12.4 Trademarks	20
12.5 Electrostatic Discharge Caution	20
12.6 Glossary	20
13 Revision History	20
14 Mechanical, Packaging, and Orderable	
Information	21

## 4 Description (continued)

The SN74AVC16T245-Q1 is designed so that the control pins (1DIR, 2DIR, 1  $\overline{OE}$ , and 2  $\overline{OE}$ ) are supplied by  $V_{CCA}$ .

This device is fully specified for partial-power-down applications using  $I_{\text{off}}$ . The  $I_{\text{off}}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V<sub>CC</sub> isolation feature ensures that if either V<sub>CC</sub> input is at GND, both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  must be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



# **5 Pin Configuration and Functions**

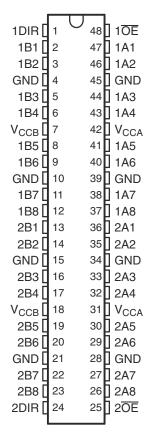


Figure 5-1. DGV Package 48-Pin TVSOP Top View

Table 5-1. Pin Functions

PIN		1/0	DECODINE						
NAME	NO.	I/O	DESCRIPTION						
1A1	47								
1A2	46								
1A3	44								
1A4	43	I/O	Input and output Deforanced to V						
1A5	41	1/0	Input and output. Referenced to V <sub>CCA</sub>						
1A6	40								
1A7	38								
1A8	37								
1B1	2								
1B2	3								
1B3	5								
1B4	6	I/O	Input and output. Referenced to V <sub>CCB</sub>						
1B5	8	1/0	imput and output. Referenced to V <sub>CCB</sub>						
1B6	9								
1B7	11								
1B8	12								

### **Table 5-1. Pin Functions (continued)**

PIN			D=2001D=1011							
NAME	NO.	I/O	DESCRIPTION							
2A1	36									
2A2	35									
2A3	33									
2A4	32	1/0	Involved autom Defendance V							
2A5	30	I/O	Input and output. Referenced to V <sub>CCA</sub>							
2A6	29									
2A7	27									
2A8	26									
2B1	13									
2B2	14									
2B3	16									
2B4	17	1/0	Input and output. Referenced to V <sub>CCB</sub>							
2B5	19	I/O								
2B6	20									
2B7	22									
2B8	23									
1DIR	1		Direction-control signal							
2DIR	24	ı	Direction-control signal							
1 ŌĒ	48		Tri-State output-mode enables. Pull $\overline{\sf OE}$ high to place all outputs in Tri-State mode.							
2 OE	25	_	Referenced to V <sub>CCA</sub>							
GND	4, 10, 15, 21, 45, 39, 34, 28	_	Ground							
V <sub>CCA</sub>	42, 31	_	A-port supply voltage. 1.2 V ≤ V <sub>CCB</sub> ≤ 3.6 V							
V <sub>CCB</sub>	7, 18	_	B-port supply voltage. 1.2 V ≤ V <sub>CCB</sub> ≤ 3.6 V							



# **6 Specifications**

## **6.1 Absolute Maximum Ratings**

over operating free-air temperature range (unless otherwise noted)(1)

		,	MIN	MAX	UNIT
V <sub>CCA</sub> V <sub>CCB</sub>	Supply voltage		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
VI	Input voltage (2)	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
\/	Voltage applied to any output	A port	-0.5	4.6	V
Vo	in the high-impedance or power-off state <sup>(2)</sup>	B port	-0.5	4.6	]
V	Voltage applied to any output in the high or low state <sup>(2) (3)</sup>	A port	-0.5	V <sub>CCA</sub> + 0.5	V
Vo	voltage applied to any output in the high of low state.	B port	-0.5	V <sub>CCB</sub> + 0.5	]
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
Io	Continuous output current	<u>'</u>		±50	mA
	Continuous current through each V <sub>CCA</sub> , V <sub>CCB</sub> , and GND		±100	mA	
T <sub>stg</sub>	Storage temperature		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- (2) The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

## 6.2 ESD Ratings

			VALUE	UNIT
		Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>		
V <sub>(ESD)</sub>	Electrostatic discharge	scharge Charged-device model (CDM), per JEDEC specification JESD22-C10		V
		Machine model (MM), per JEDEC specification JESD22-A115-A	±200	

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

## **6.3 Recommended Operating Conditions**

over operating free-air temperature range (unless otherwise noted)(1) (2) (3)

			V <sub>CCI</sub>	V <sub>cco</sub>	MIN	MAX	UNIT		
V <sub>CCA</sub> , V <sub>CCB</sub>	Supply voltage				1.2	3.6	V		
			1.2 V to 1.95 V		V <sub>CCI</sub> × 0.65				
V <sub>IH</sub>	High-level input voltage	Data inputs <sup>(4)</sup>	1.95 V to 2.7 V		1.6		V		
	Input voltage		2.7 V to 3.6 V		2				
			1.2 V to 1.95 V			V <sub>CCI</sub> × 0.35			
$V_{IL}$	Low-level input voltage	Data inputs <sup>(4)</sup>	1.95 V to 2.7 V			0.7	V		
			2.7 V to 3.6 V			0.8			
			1.2 V to 1.95 V		V <sub>CCA</sub> × 0.65				
$V_{IH}$	High-level input voltage	DIR (referenced to V <sub>CCA</sub> ) <sup>(5)</sup>	1.95 V to 2.7 V		1.6		V		
	mpat remage	(Total and a to VCCA)	2.7 V to 3.6 V		2				
	Low-level input voltage		1.2 V to 1.95 V			V <sub>CCA</sub> × 0.35			
$V_{IL}$		DIR (referenced to V <sub>CCA</sub> ) <sup>(5)</sup>	1.95 V to 2.7 V			0.7	V		
		(Colorelloca to VCCA)	2.7 V to 3.6 V			0.8			
VI	Input voltage				0	3.6	V		
	Output voltage	Active state			0	V <sub>CCO</sub>	V		
Vo	Output voitage	3-state			0	3.6	V		
				1.2 V		-3			
				1.4 V to 1.6 V		-6			
I <sub>OH</sub>	High-level output current			1.65 V to 1.95 V		-8	mA		
				2.3 V to 2.7 V		-9			
				3 V to 3.6 V		-12			
				1.2 V		3			
				1.4 V to 1.6 V		6			
I <sub>OL</sub>	Low-level output current			1.65 V to 1.95 V		8	mA		
				2.3 V to 2.7 V		9			
				3 V to 3.6 V		12			
Δt/Δν	Input transition rise or fall	rate				5	ns/V		
T <sub>A</sub>	Operating free-air temper	ature			-40	125	°C		

- (1)  $V_{\text{CCI}}$  is the  $V_{\text{CC}}$  associated with the data input port.
- (2)  $V_{\text{CCO}}$  is the  $V_{\text{CC}}$  associated with the output port.
- All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. See *Implications of Slow or* Floating CMOS Inputs
- (4) For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCI</sub> × 0.7 V, V<sub>IL</sub> max = V<sub>CCI</sub> × 0.3 V.
   (5) For V<sub>CCA</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCA</sub> × 0.7 V, V<sub>IL</sub> max = V<sub>CCA</sub> × 0.3 V.

#### 6.4 Thermal Information

		SN74AVC16T245-Q1			
	THERMAL METRIC <sup>(1)</sup>	DGV (TVSOP)	UNIT		
		48 PINS			
R <sub>0JA</sub>	Junction-to-ambient thermal resistance	77.2	°C/W		
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	31.4	°C/W		
$R_{\theta JB}$	Junction-to-board thermal resistance	39.5	°C/W		
ΨЈΤ	Junction-to-top characterization parameter	3.5	°C/W		
ΨЈВ	Junction-to-board characterization parameter	39	°C/W		
R <sub>θJC(bot)</sub>	Junction-to-case (bottom) thermal resistance	N/A	°C/W		

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

Copyright © 2024 Texas Instruments Incorporated



#### **6.5 Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)(2) (3)

PAR	AMETER	TEST COND	TIONS	V <sub>CCA</sub>	V <sub>CCB</sub>	T <sub>A</sub>	MIN	TYP	MAX	UNIT	
		I <sub>OH</sub> = -100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V	T <sub>A</sub> = -40°C to 125°C	V <sub>CCO</sub> - 0.2				
		I <sub>OH</sub> = -3 mA	1	1.2 V	1.2 V	T <sub>A</sub> = 25°C		0.95			
		I <sub>OH</sub> = -6 mA		1.4 V	1.4 V	T <sub>A</sub> = -40°C to 125°C	1				
V <sub>OH</sub>		I <sub>OH</sub> = -8 mA	$I_{OH} = -8 \text{ mA}$ $V_I = V_{IH}$		1.65 V	T <sub>A</sub> = -40°C to 125°C	1.15			V	
		I <sub>OH</sub> = -9 mA		2.3 V	2.3 V	T <sub>A</sub> = -40°C to 125°C	1.75				
		I <sub>OH</sub> = -12 mA		3 V	3 V	T <sub>A</sub> = -40°C to 125°C	2.3				
		I <sub>OL</sub> = 100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V	T <sub>A</sub> = -40°C to 125°C			0.2		
		$I_{OL}$ = 3 mA		1.2 V	1.2 V	T <sub>A</sub> = 25°C		0.15			
		I <sub>OL</sub> = 6 mA		1.4 V	1.4 V	T <sub>A</sub> = -40°C to 125°C			0.4		
V <sub>OL</sub>		I <sub>OL</sub> = 8 mA	V <sub>I</sub> = V <sub>IL</sub>	1.65 V	1.65 V	T <sub>A</sub> = -40°C to 125°C			0.45	V	
		I <sub>OL</sub> = 9 mA		2.3 V	2.3 V	T <sub>A</sub> = -40°C to 125°C			0.55		
		I <sub>OL</sub> = 12 mA		3 V	3 V	T <sub>A</sub> = -40°C to 125°C			0.7		
	Control					T <sub>A</sub> = 25°C		±0.025	±0.25		
I	inputs	V <sub>I</sub> = V <sub>CCA</sub> or GND		1.2 V to 3.6 V	1.2 V to 3.6 V	T <sub>A</sub> = -40°C to 125°C			±2	μA	
	A or B					T <sub>A</sub> = 25°C		±0.1	±2.5		
off	port	V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V		0 V	0 to 3.6 V	T <sub>A</sub> = -40°C to 125°C			±10	μA	
ОП		V  01 V()= 0 to 0.0 V				T <sub>A</sub> = 25°C		±0.5	±2.5	,	
	port			0 to 3.6 V	0 V	T <sub>A</sub> = -40°C to 125°C			±10	)	
(4)	A or B	$V_O = V_{CCO}$ or GND,		0.01/		T <sub>A</sub> = 25°C		±0.5	±2.5		
oz <sup>(1)</sup>	port	V <sub>I</sub> = V <sub>CCI</sub> or GND, <del>OE</del> =V <sub>IH</sub>		3.6 V	3.6 V	T <sub>A</sub> = -40°C to 125°C			±10	μA	
				1.2 V to 3.6 V	1.2 V to 3.6 V	T <sub>A</sub> = -40°C to 125°C			30		
CCA		$V_I = V_{CCI}$ or GND, $I_O = 0$		0 V	3.6 V	T <sub>A</sub> = -40°C to 125°C			-40	μΑ	
				3.6 V	0 V	T <sub>A</sub> = -40°C to 125°C			30		
_				1.2 V to 3.6 V	1.2 V to 3.6 V	T <sub>A</sub> = -40°C to 125°C			30		
ССВ		$V_I = V_{CCI}$ or GND, $I_O = 0$			3.6 V	T <sub>A</sub> = -40°C to 125°C			30	μΑ	
				3.6 V	0 V	T <sub>A</sub> = -40°C to 125°C			-40		
CCA+ I	ССВ	$V_I = V_{CCI}$ or GND, $I_O = 0$		1.2 V to 3.6 V	1.2 V to 3.6 V	T <sub>A</sub> = -40°C to 125°C			60	μΑ	
Ci	Control inputs	V <sub>I</sub> = 3.3 V or GND		3.3 V	3.3 V	T <sub>A</sub> = 25°C		3.5		pF	
Cio	A or B	V <sub>O</sub> = 3.3 V or GND	V <sub>O</sub> = 3.3 V or GND		3.3 V	T <sub>A</sub> = 25°C		7		pF	

For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.

<sup>(2)</sup> 

<sup>(3)</sup> 

# 6.6 Switching Characteristics: $V_{CCA}$ = 1.2 V

over recommended operating free-air temperature range, V<sub>CCA</sub> = 1.2 V (see Figure 7-1)

PARAMETER	FROM	то	V <sub>CCB</sub> =	1.2 V	Vc	<sub>CB</sub> = 1.5 V	'	Vcc	<sub>B</sub> = 1.8 V	'	Vcc	<sub>B</sub> = 2.5 \	٧	V <sub>cc</sub>	<sub>B</sub> = 3.3	v	UNIT							
PARAMETER	(INPUT)	(OUTPUT)	MIN T	P MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNII							
t <sub>PLH</sub>	Α	В	4	.1		3.3			3			2.8			3.2		ns							
t <sub>PHL</sub>	^		4	.1		3.3			3			2.8			3.2		115							
t <sub>PLH</sub>	В	R	A	4	.4		4			3.8			3.6			3.5		ne						
t <sub>PHL</sub>	ь		4.4		4			3.8		3.6			3.5		ns									
t <sub>PZH</sub>	ŌĒ	ŌĒ	ŌĒ	А	6	.4		6.4			6.4			6.4			6.4		ns					
t <sub>PZL</sub>	OL		6	.4		6.4			6.4			6.4			6.4		115							
t <sub>PZH</sub>	ŌĒ	В		6		4.6			4			3.4			3.2		ns							
t <sub>PZL</sub>				6		4.6			4			3.4			3.2		115							
$t_{PHZ}$	ŌĒ	OF	ŌĒ	ŌĒ	ŌĒ.	OE	ŌĒ	OF	A	6	.6		6.6			6.6			6.6			6.8		ns
t <sub>PLZ</sub>			6	.6		6.6			6.6			6.6			6.8		115							
t <sub>PHZ</sub>	OF.	ŌĒ	OF.	В		6		4.9			4.9			4.2			5.3		ns					
t <sub>PLZ</sub>	OL			6		4.9			4.9			4.2			5.3		113							

# 6.7 Switching Characteristics: $V_{CCA}$ = 1.5 V ± 0.1 V

over recommended operating free-air temperature range,  $V_{CCA}$  = 1.5 V ± 0.1 V (see Figure 7-1)

DADAMETED	FROM	то	V <sub>CCB</sub> = 1.2 V			V <sub>CCB</sub> = 1.5 V ± 0.1 V			V <sub>CCB</sub> = 1.8	V <sub>CCB</sub> = 1.8 V ± 0.15 V			2.5 V ± 0.	.2 V	V <sub>CCB</sub> = 3.3 V ± 0.3 V			UNIT				
PARAMETER	(INPUT)	(OUTPUT)	MIN -	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP N	MAX	MIN	TYP	MAX	UNII				
t <sub>PLH</sub>	Α	В		3.6		0.5		9.2	0.5		8.2	0.5		7.1	0.5		6.7	no				
t <sub>PHL</sub>	A	В		3.6		0.5		9.2	0.5		8.2	0.5		7.1	0.5		6.7	ns				
t <sub>PLH</sub>	— В	Α		3.3		0.5		9.2	0.5		8.9	0.5		8.6	0.5		8.5	ns				
t <sub>PHL</sub>		Б	ь	^		3.3		0.5		9.2	0.5		8.9	0.5		8.6	0.5		8.5	115		
t <sub>PZH</sub>	ŌĒ	ŌĒ	ŌĒ	Α		4.3		0.5		13.1	0.5		13.1	0.5		13.1	0.5		13.1	ns		
t <sub>PZL</sub>	OE	^		4.3		0.5		13.1	0.5		13.1	0.5		13.1	0.5		13.1	115				
t <sub>PZH</sub>	ŌĒ	В		5.6		0.5		13.1	0.5		11.1	0.5		8.9	0.5		8.2	no				
t <sub>PZL</sub>	ÜE	OE	OE	OE	OE OE	В		5.6		0.5		13.1	0.5		11.1	0.5		8.9	0.5		8.2	ns
t <sub>PHZ</sub>	ŌĒ	ŌĒ	ŌĒ	А		4.5		0.5		12.1	0.5		12.1	0.5		12.1	0.5		12.1			
t <sub>PLZ</sub>				A		4.5		0.5		12.1	0.5		12.1	0.5		12.1	0.5		12.1	ns		
t <sub>PHZ</sub>	- OE	В		5.5		0.5		11.7	0.5		10.5	0.5		9.5	0.5		9.3	no				
t <sub>PLZ</sub>		OE	OE	ŌĒ	0		5.5		0.5		11.7	0.5		10.5	0.5		9.5	0.5		9.3	ns	

# 6.8 Switching Characteristics: $V_{CCA}$ = 1.8 V $\pm$ 0.15 V

over recommended operating free-air temperature range,  $V_{CCA}$  = 1.8 V ± 0.15 V (see Figure 7-1)

PARAMETER	FROM	то	Vcc	<sub>B</sub> = 1.2 V		V <sub>CCB</sub> =	1.5 V ± 0	.1 V	V <sub>CCB</sub> =	1.8 V ± 0	.15 V	V <sub>CCB</sub> =	2.5 V ± 0	).2 V	V <sub>CCB</sub> = :	3.3 V ±	0.3 V	UNIT		
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNII		
t <sub>PLH</sub>	Α	В		3.4		0.5		8.9	0.5		7.8	0.5		6.7	0.5		6.3	ns		
t <sub>PHL</sub>	A			3.4		0.5		8.9	0.5		7.8	0.5		6.7	0.5		6.3	115		
t <sub>PLH</sub>	В	А		3		0.5		8.2	0.5		7.8	0.5		7.5	0.5		7.4	ns		
t <sub>PHL</sub>	ь			3		0.5		8.2	0.5		7.8	0.5		7.5	0.5		7.4	115		
t <sub>PZH</sub>	ŌĒ	Α		3.4		0.5		10.8	0.5		10.8	0.5		10.8	0.5		10.8	ns		
t <sub>PZL</sub>	OE			3.4		0.5		10.8	0.5		10.8	0.5		10.8	0.5		10.8	115		
t <sub>PZH</sub>	OE.	В		5.4		0.5		12.2	0.5		10.4	0.5		8.3	0.5		7.5	ns		
t <sub>PZL</sub>	ŌĒ	—— ŌE			5.4		0.5		12.2	0.5		10.4	0.5		8.3	0.5		7.5	115	
t <sub>PHZ</sub>	ŌĒ	OE A			4.2		0.5		10.7	0.5		10.7	0.5		10.7	0.5		10.7	no	
t <sub>PLZ</sub>			ŌĒ A	ŌĒ	ŌĒ			4.2		0.5		10.7	0.5		10.7	0.5		10.7	0.5	
t <sub>PHZ</sub>	OE.	ŌE B		5.2		0.5		11.4	0.5		8.9	0.5		8.9	0.5		8.7	ns		
t <sub>PLZ</sub>	ŌĒ	ŌĒ			5.2		0.5		11.4	0.5		8.9	0.5		8.9	0.5		8.7	115	

# 6.9 Switching Characteristics: $V_{CCA}$ = 2.5 V ± 0.2 V

over recommended operating free-air temperature range, V<sub>CCA</sub> = 2.5 V ± 0.2 V (see Figure 7-1)

PARAMETER	FROM	то	V <sub>CCB</sub> = 1.2	: <b>V</b>	V <sub>CCB</sub> =	1.5 V ± 0.	1 V	V <sub>CCB</sub> = 1	1.8 V ± 0.	15 V	V <sub>CCB</sub> =	2.5 V ±	0.2 V	V <sub>CCB</sub> = :	3.3 V ±	0.3 V	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	MIN TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t <sub>PLH</sub>	Α	В	3.2		0.5		9.6	0.5		7.5	0.5		6.3	0.5		5.8	ns	
t <sub>PHL</sub>	^		3.2		0.5		8.6	0.5		7.5	0.5		6.3	0.5		5.8	113	
t <sub>PLH</sub>	В	Α	2.6		0.5		7.1	0.5		6.7	0.5		6.3	0.5		6.2	ns	
t <sub>PHL</sub>	Ь	_ ^	2.6		0.5		7.1	0.5		6.7	0.5		6.3	0.5		6.2	115	
t <sub>PZH</sub>	ŌĒ	Α	2.5		0.5		8.3	0.5		8.3	0.5		8.3	0.5		8.3	ns	
t <sub>PZL</sub>	OE	_ ^	2.5		0.5		8.3	0.5		8.3	0.5		8.3	0.5		8.3	115	
t <sub>PZH</sub>	ŌĒ	В	5.2		0.5		12.4	0.5		10.3	0.5		8.1	0.5		7.5	ns	
t <sub>PZL</sub>	OE		5.2		0.5		12.4	0.5		10.3	0.5		8.1	0.5		7.5	115	
t <sub>PHZ</sub>	ŌĒ	Α	3		0.5		9.1	0.5		9.1	0.5		9.1	0.5		9.1		
t <sub>PLZ</sub>	OE	_ ^	3		0.5		9.1	0.5		9.1	0.5		9.1	0.5		9.1	ns	
t <sub>PHZ</sub>	OF	ь	5		0.5		10.9	0.5		9.6	0.5		9.1	0.5		8.2	ns	
t <sub>PLZ</sub>	OE	ŌE B		5		0.5		10.9	0.5		9.6	0.5		9.1	0.5		8.2	115



# 6.10 Switching Characteristics: $V_{CCA}$ = 3.3 V ± 0.3 V

over recommended operating free-air temperature range,  $V_{CCA}$  = 3.3 V  $\pm$  0.3 V (see Figure 7-1)

PARAMETER	FROM	то	V <sub>cc</sub>	<sub>B</sub> = 1.2 \	/	V <sub>CCB</sub> =	1.5 V ± 0.1	٧	V <sub>CCB</sub> = 1	.8 V ± 0.15	٧	V <sub>CCB</sub> = 2	2.5 V ± 0	).2 V	V <sub>CCB</sub> = 3	3.3 V ±	0.3 V	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP N	IAX	MIN	TYP	MAX	MIN	TYP	MAX	UNII
t <sub>PLH</sub>	А	В		3.2		0.5		8.5	0.5		7.4	0.5		6.2	0.5		5.7	ns
t <sub>PHL</sub>	^			3.2		0.5		8.5	0.5		7.4	0.5		6.2	0.5		5.7	115
t <sub>PLH</sub>	В	A		2.8		0.5		6.7	0.5		6.3	0.5		5.8	0.5		5.7	ns
t <sub>PHL</sub>	Ь	^		2.8		0.5		6.7	0.5		6.3	0.5		5.8	0.5		5.7	115
t <sub>PZH</sub>	ŌĒ	A		2.2		0.5		7.3	0.5		7.2	0.5		7.1	0.5		7	ns
t <sub>PZL</sub>	OL	^		2.2		0.5		7.3	0.5		7.2	0.5		7.1	0.5		7	115
t <sub>PZH</sub>	ŌĒ	В		5.1		0.5		12.3	0.5	1	0.2	0.5		7.9	0.5		7	ns
t <sub>PZL</sub>	OL			5.1		0.5		12.3	0.5	1	0.2	0.5		7.9	0.5		7	115
t <sub>PHZ</sub>	ŌĒ	A		3.4		0.5		8	0.5		8	0.5		8	0.5		8	ns
t <sub>PLZ</sub>	OL	_ ^		3.4		0.5		8	0.5		8	0.5		8	0.5		8	115
t <sub>PHZ</sub>	OF	В		4.9		0.5		10.7	0.5		9.5	0.5		8.2	0.5		8	ns
t <sub>PLZ</sub>	ŌĒ			4.9		0.5		10.7	0.5		9.5	0.5		8.2	0.5		8	

# **6.11 Operating Characteristics**

T<sub>A</sub>= 25°C

1A- 25	,																	
	PARAMETEI	R	TEST CONDITIONS	V <sub>CCA</sub> = V <sub>CCB</sub>	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.2 V			V <sub>CCA</sub> =	• V <sub>CCB</sub> = 1	.8 V	V <sub>CCA</sub>	= V <sub>CCB</sub> =	2.5 V	V <sub>CCA</sub> =	V <sub>CCB</sub> = 3	3.3 V	UNIT	
			CONDITIONS	MIN TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
	A to B	Outputs enabled		1			1			1			1			2		
C <sub>pdA</sub> (1)	7102	Outputs disabled	C <sub>L</sub> = 0, f = 10 MHz,	1			1			1			1			1		pF
OpdA	B to A	Outputs enabled	$t_r = t_f = 1 \text{ ns}$	13			13			14			15			16		рг
	BIOA	Outputs disabled		1			1			1			1			1		
	A to B	Outputs enabled		13			13			14			15			16		
C <sub>pdB</sub> (1)	A to B	Outputs disabled	$C_L = 0$ ,	1		1			1		1			1			pF	
OpdB */	B to A	Outputs enabled $f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$	1			1			1			1			2		pr	
		Outputs disabled		1			1			1			1			1		

<sup>(1)</sup> Power dissipation capacitance per transceiver



#### 6.12 Typical Characteristics

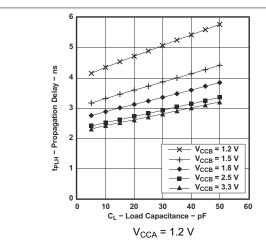


Figure 6-1. Typical Propagation Delay t<sub>PLH</sub> (A to B) vs Load Capacitance

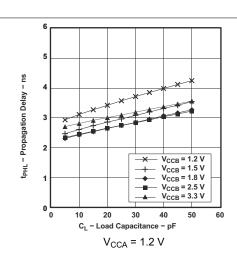


Figure 6-2. Typical Propagation Delay t<sub>PHL</sub> (A to B) vs Load Capacitance

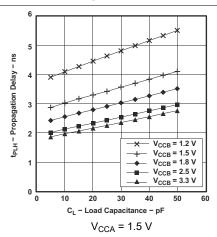


Figure 6-3. Typical Propagation Delay t<sub>PLH</sub> (A to B) vs Load Capacitance

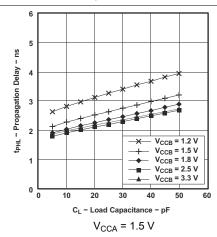


Figure 6-4. Typical Propagation Delay t<sub>PHL</sub> (A to B) vs Load Capacitance

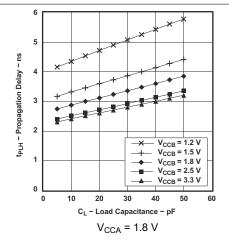


Figure 6-5. Typical Propagation Delay t<sub>PLH</sub> (A to B) vs Load Capacitance

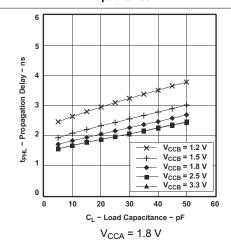


Figure 6-6. Typical Propagation Delay t<sub>PHL</sub> (A to B) vs Load Capacitance

Submit Document Feedback

Copyright © 2024 Texas Instruments Incorporated

## **6.12 Typical Characteristics (continued)**

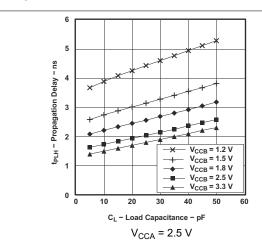


Figure 6-7. Typical Propagation Delay t<sub>PLH</sub> (A to B) vs Load Capacitance

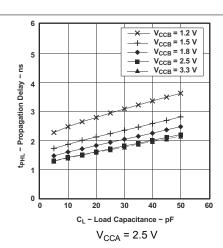


Figure 6-8. Typical Propagation Delay t<sub>PHL</sub> (A to B) vs Load Capacitance

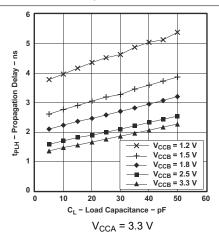


Figure 6-9. Typical Propagation Delay  $t_{\rm PLH}$  (A to B) vs Load Capacitance

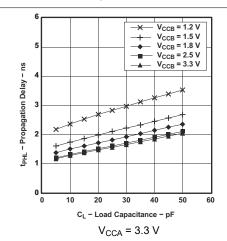
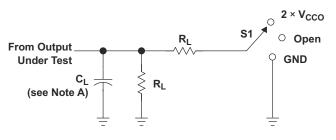


Figure 6-10. Typical Propagation Delay t<sub>PHL</sub> (A to B) vs Load Capacitance



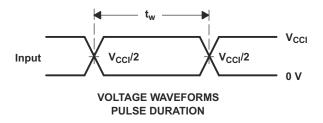
#### 7 Parameter Measurement Information

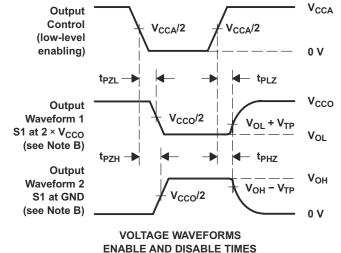


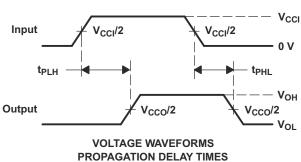
TEST	<b>S</b> 1
t <sub>pd</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	2 × V <sub>CCO</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

**LOAD CIRCUIT** 

V <sub>CCO</sub>	CL	$R_L$	V <sub>TP</sub>
1.2 V	15 pF	<b>2 k</b> Ω	0.1 V
$1.5~V\pm0.1~V$	15 pF	<b>2 k</b> Ω	0.1 V
$1.8 V \pm 0.15 V$	15 pF	<b>2 k</b> Ω	0.15 V
$2.5~V\pm0.2~V$	15 pF	<b>2 k</b> Ω	0.15 V
3.3 V $\pm$ 0.3 V	15 pF	<b>2 k</b> Ω	0.3 V







NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω, dv/dt ≥ 1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.
- I.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.

Figure 7-1. Load Circuit and Voltage Waveforms

Submit Document Feedback

Copyright © 2024 Texas Instruments Incorporated

## 8 Detailed Description

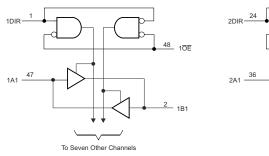
#### 8.1 Overview

The SN74AVC16T245-Q1 is a 16-bit, dual-supply, noninverting, bidirectional voltage level translation. Pins A and control pins (DIR and  $\overline{\text{OE}}$ ) are supported by  $V_{\text{CCA}}$  and B pins are supported by  $V_{\text{CCB}}$ . The A port can accept I/O voltages ranging from 1.2 V to 3.6 V, while the B port can accept I/O voltages from 1.2 V to 3.6 V. A high on DIR allows data transmission from A to B and a low on DIR allows data transmission from B to A when  $\overline{\text{OE}}$  is set to low. When  $\overline{\text{OE}}$  is set to high, both A and B are in the high-impedance state.

This device is fully specified for partial-power-down applications using off output current (I<sub>off</sub>).

The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at GND, both ports are put in a high-impedance state.

#### 8.2 Functional Block Diagram



Copyright © 2016, Texas Instruments Incorporated

To Seven Other Channels

#### 8.3 Feature Description

# 8.3.1 Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range

Both  $V_{CCA}$  and  $V_{CCB}$  can be supplied at any voltage from 1.2 V to 3.6 V, making the device suitable for translating between any of the low voltage nodes (1.2 V, 1.8 V, 2.5 V, and 3.3 V).

#### 8.3.2 Partial-Power-Down Mode Operation

This device is fully specified for partial-power-down applications using off output current (I<sub>off</sub>). The I<sub>off</sub> circuitry prevents backflow current by disabling I/O output circuits when device is in partial power-down mode.

#### 8.3.3 V<sub>CC</sub> Isolation

The  $V_{CC}$  isolation feature ensures that if either  $V_{CCA}$  or  $V_{CCB}$  are at GND, both ports are in a high-impedance state ( $I_{OZ}$  shown in Section 6.5). This prevents false logic levels from being presented to either bus.

#### 8.4 Device Functional Modes

The SN74AVC16T245-Q1 is a voltage level translator that can operate from 1.2 V to 3.6 V ( $V_{CCA}$ ) and 1.2 V to 3.6 V ( $V_{CCB}$ ). The signal translation between 1.2 V and 3.6 V requires direction control and output enable control. When  $\overline{OE}$  is low and DIR is high, data transmission is from A to B. When  $\overline{OE}$  is low and DIR is low, data transmission is from B to A. When  $\overline{OE}$  is high, both output ports will be high-impedance. Table 8-1 lists the functions.

Table 8-1. Function Table (Each 16-Bit Section)

CONTROL	. INPUTS	OUTPUT CII	RCUITS	OPERATION
ŌĒ	DIR	A PORT	B PORT	OPERATION
L	L	Enabled	Hi-Z	B data to A bus
L	Н	Hi-Z	Enabled	A data to B bus
Н	X	Hi-Z	Hi-Z	Isolation

Copyright © 2024 Texas Instruments Incorporated

Submit Document Feedback

# 9 Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 9.1 Application Information

The SN74AVC16T245-Q1 device can be used in level-shifting applications for interfacing devices and addressing mixed voltage incompatibility. The SN74AVC16T245-Q1 device is ideal for data transmission where direction is different for each channel.

#### 9.1.1 Enable Times

Calculate the enable times for the SN74AVC16T45 using the following formulas:

$$t_{PZH}$$
 (DIR to A) =  $t_{PLZ}$  (DIR to B) +  $t_{PLH}$  (B to A) (1)

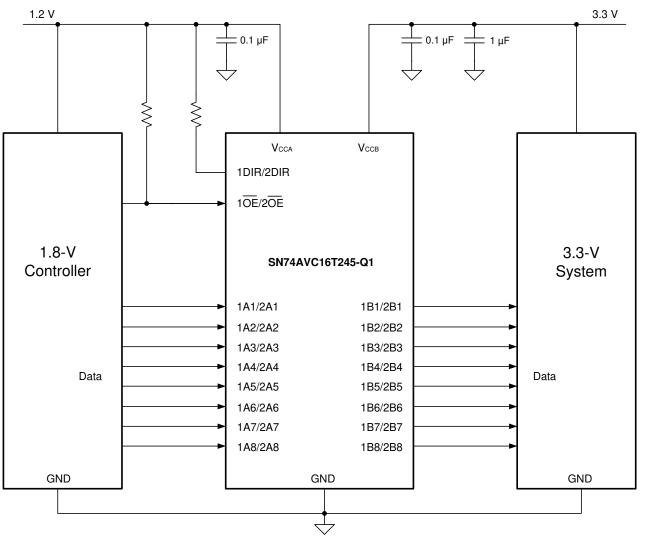
$$t_{PZL}$$
 (DIR to A) =  $t_{PHZ}$  (DIR to B) +  $t_{PHL}$  (B to A) (2)

$$t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)$$
(3)

$$t_{PZL}$$
 (DIR to B) =  $t_{PHZ}$  (DIR to A) +  $t_{PHL}$  (A to B) (4)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC16T245-Q1 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

### 9.2 Typical Application



Copyright © 2016, Texas Instruments Incorporated

Figure 9-1. Typical Application Schematic

### 9.2.1 Design Requirements

This device uses drivers which are enabled depending on the state of the DIR pin. The designer must know the intended flow of data and take care not to violate any of the high or low logic levels. Unused data inputs must not be floating, as this can cause excessive internal leakage on the input CMOS structure. Tie any unused input and output ports directly to ground.

For this design example, use the parameters listed in Table 9-1.

**Table 9-1. Design Parameters** 

DESIGN PARAMETER	EXAMPLE VALUE
Input voltage range	1.2 V
Output voltage range	3.3 V

Copyright © 2024 Texas Instruments Incorporated

Submit Document Feedback

#### 9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
  - Use the supply voltage of the device that is driving the SN74AVC16T245-Q1 device to determine the input voltage range. For a valid logic high the value must exceed the V<sub>IH</sub> of the input port. For a valid logic low the value must be less than the V<sub>II</sub> of the input port.
- Output voltage range
  - Use the supply voltage of the device that the SN74AVC16T245-Q1 device is driving to determine the output voltage range.

#### 9.2.3 Application Curve

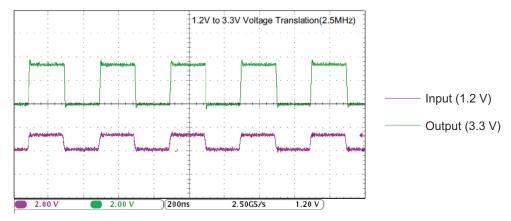


Figure 9-2. Translation Up (1.2 V to 3.3 V) at 2.5 MHz

## 10 Power Supply Recommendations

The SN74AVC16T245-Q1 device uses two separate configurable power-supply rails,  $V_{CCA}$  and  $V_{CCB}$ .  $V_{CCA}$  accepts any supply voltage from 1.2 V to 3.6 V and  $V_{CCB}$  accepts any supply voltage from 1.2 V to 3.6 V. The A port and B port are designed to track  $V_{CCA}$  and  $V_{CCB}$ , respectively, allowing for low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The output-enable  $\overline{OE}$  input circuit is designed so that it is supplied by  $V_{CCA}$  and when the  $\overline{OE}$  input is high, all outputs are placed in the high-impedance state. To ensure the high-impedance state of the outputs during power up or power down, the  $\overline{OE}$  input pin must be tied to  $V_{CCA}$  through a pullup resistor and must not be enabled until  $V_{CCA}$  and  $V_{CCB}$  are fully ramped and stable. The minimum value of the pullup resistor to  $V_{CCA}$  is determined by the current-sinking capability of the driver.

#### 11 Layout

#### 11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit board layout guidelines is recommended:

- Bypass capacitors must be used on power supplies.
- Short trace lengths must be used to avoid excessive loading.
- Placing pads on the signal paths for loading capacitors or pullup resistors to help adjust rise and fall times of signals depending on the system requirements.



#### 11.2 Layout Example



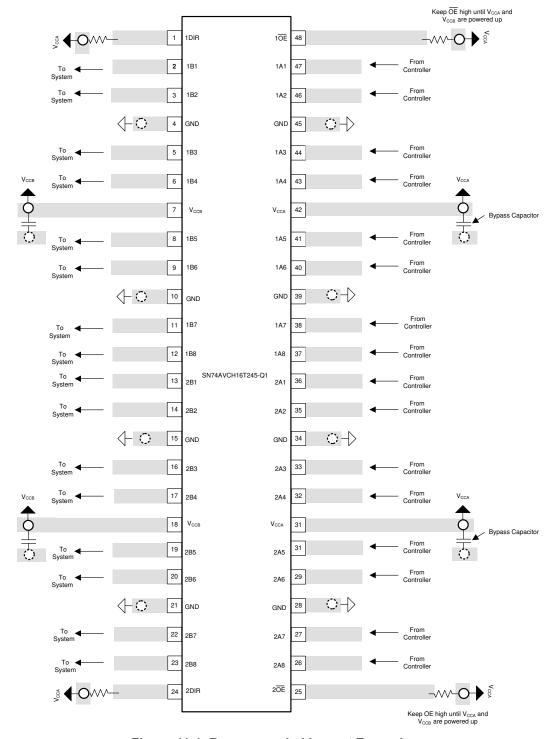


Figure 11-1. Recommended Layout Example

# 12 Device and Documentation Support

## 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

- CMOS Power Consumption and Cpd Calculation
- IC Package Thermal Metrics application report
- Implications of Slow or Floating CMOS Inputs

#### 12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on Notifications to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 12.3 Support Resources

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 12.4 Trademarks

TI E2E<sup>™</sup> is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

#### 12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 12.6 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

#### 13 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

#### Changes from Revision A (February 2016) to Revision B (March 2024) **Page**

#### Changes from Revision \* (September 2008) to Revision A (February 2016) **Page**

- Added ESD Ratings table. Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendationssection, Layout section, Device and Documentation
- Deleted Overvoltage-Tolerant Inputs/Outputs Allow Mixed- Voltage-Mode Data Communications bullet from



# 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

7-Oct-2025 www.ti.com

#### PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
CAVC16T245QDGVRQ1	Active	Production	TVSOP (DGV)   48	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	WF245Q
CAVC16T245QDGVRQ1.B	Active	Production	TVSOP (DGV)   48	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	WF245Q

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN74AVC16T245-Q1:

Catalog: SN74AVC16T245

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No. RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



# **PACKAGE OPTION ADDENDUM**

www.ti.com 7-Oct-2025

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 24-Jul-2025

### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CAVC16T245QDGVRQ1	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 24-Jul-2025



## \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CAVC16T245QDGVRQ1	TVSOP	DGV	48	2000	353.0	353.0	32.0

## DGV (R-PDSO-G\*\*)

#### 24 PINS SHOWN

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

#### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2025. Texas Instruments Incorporated